

Stripper SLOTOSTRIP IN 2180

Stripper SLOTOSTRIP IN 2180 is a two-step chemical process for the removal of indium from copper, brass and nickel.

When stripping copper respectively brass, in the first stage indium is removed by the support of Stripper SLOTOSTRIP IN 2180. In a second step, Copper Activation S 40 supports the removal of the copper-indium diffusion layer.

If there is a nickel diffusion barrier layer, a post-treatment with Copper Activation S 40 is not necessary. The released nickel layer can also be removed e.g. by using Stripper L 10 (BATH 01034-E) or Stripper N 10 (BATH 01039-E).

The information in this data sheet is based on laboratory as well as practical experience. Figures quoted for operating limits and replenishment quantities are for guidance. Actual values necessary will depend on the components being plated (material and geometry), their application and plating plant conditions.

Important:

Please read this instruction carefully prior to the use of the process and carefully follow all the parameters that have a direct influence on the operation. We reserve the right to make technical changes. In the interest of safety, please pay attention to the hazard warnings on the labels of the containers. The minimum shelf life of the products is included on the labels and is also available in the appropriate Quality Assurance (QA03).

The current IMDS number of the layer deposited from the process is available on the internet at www.schloetter.com/downloads.

For the storage of chemical products the TRGS 510 must be followed.

If the additives used in this process contain a SVHC-substance, then this will be specified in the corresponding Material Safety Data Sheet, section 15.

